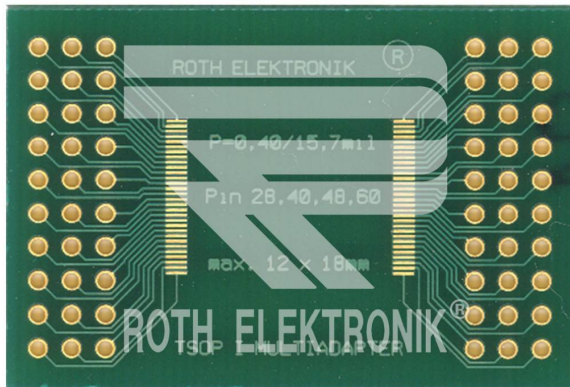


Adapter TSOP I



RE900-01

- FR4 EPOXY fibre-glass FR4 1.50 mm double-sided 35 µm CU (pth)
- solder and component side with chemical NI/AU surface and solder stop mask
- pitch spacings:
0.40 mm (15.7 mil)
- Pins:
28, 40, 48, 60
- hole dia Ø 1.00 mm
- Gerber data for manufacture of the soldering paste imprint will be provided free of charge on request
- size: 43,5 x 29,0 mm